

#### 118TH CONGRESS 2D SESSION

# S. 4585

To prohibit covered entities that receive financial assistance relating to semiconductors from purchasing certain semiconductor manufacturing equipment from foreign entities of concern or subsidiaries of foreign entities of concern, and for other purposes.

### IN THE SENATE OF THE UNITED STATES

June 18, 2024

Mr. Kelly (for himself and Mrs. Blackburn) introduced the following bill; which was read twice and referred to the Committee on Finance

## A BILL

To prohibit covered entities that receive financial assistance relating to semiconductors from purchasing certain semiconductor manufacturing equipment from foreign entities of concern or subsidiaries of foreign entities of concern, and for other purposes.

- 1 Be it enacted by the Senate and House of Representa-
- 2 tives of the United States of America in Congress assembled,
- 3 SECTION 1. SHORT TITLE.
- 4 This Act may be cited as the "The Chip Equipment
- 5 Quality, Usefulness, and Integrity Protection Act of
- 6 2024" or the "Chip EQUIP Act of 2024".

1	SEC. 2. PURCHASES OF SEMICONDUCTOR MANUFAC-
2	TURING EQUIPMENT.
3	(a) Definitions.—Section 9901 of the William M.
4	(Mac) Thornberry National Defense Authorization Act for
5	Fiscal Year 2021 (15 U.S.C. 4651) is amended—
6	(1) by redesignating paragraphs (2), (3), (4),
7	(5), $(6)$ , $(7)$ , $(8)$ , $(9)$ , $(10)$ , $(11)$ , $(12)$ , and $(13)$ as
8	paragraphs (3), (4), (6), (7), (8), (9), (10), (11),
9	(12), (13), (14), and (15), respectively;
10	(2) by inserting after paragraph (1) the fol-
11	lowing:
12	"(2) The term 'completed, fully assembled'
13	means the state in which all (or substantially all)
14	necessary parts, chambers, subsystems, and sub-
15	components have been put together, resulting in a
16	ready-to-use or ready-to-install item to be directly
17	purchased from an entity.";
18	(3) in subparagraph (A) of paragraph (4), as so
19	redesignated, by striking "paragraph (2)" and in-
20	serting "paragraph (3)"; and
21	(4) by inserting after paragraph (4), as so re-
22	designated, the following:
23	"(5) The term 'ineligible equipment'—
24	"(A) means completed, fully assembled
25	semiconductor manufacturing equipment that is
26	manufactured or assembled by a foreign entity

1	of concern or subsidiary of a foreign entity of
2	concern and used in the fabrication, assembly,
3	testing, advanced packaging, production, or re-
4	search and development of semiconductors;
5	"(B) includes—
6	"(i) deposition equipment;
7	"(ii) etching equipment;
8	"(iii) lithography equipment;
9	"(iv) inspection and measuring equip-
10	ment;
11	"(v) wafer slicing equipment;
12	"(vi) wafer dicing equipment;
13	"(vii) wire bonders;
14	"(viii) ion implantation equipment;
15	"(ix) chemical mechanical polishing;
16	and
17	"(x) diffusion or oxidation furnaces;
18	and
19	"(C) does not include any part, chamber,
20	subsystem, or subcomponent that enables or is
21	incorporated into such equipment.".
22	(b) Ineligible Use of Funds.—Section 9902 of
23	the William M. (Mac) Thornberry National Defense Au-
24	thorization Act for Fiscal Year 2021 (15 U.S.C. 4652)
25	is amended by adding at the end the following:

1	"(j) Ineligible Use of Funds.—
2	"(1) In general.—Subject to paragraph (2),
3	the Secretary shall include in the terms of each
4	agreement with a covered entity for the award of
5	Federal financial assistance under this section prohi-
6	bitions with respect to a project relating to the pro-
7	curement, installation, or use of ineligible equip-
8	ment.
9	"(2) WAIVER.—The Secretary may waive the
10	prohibitions described in paragraph (1) if—
11	"(A) the ineligible equipment to be pur-
12	chased by the applicable covered entity is not
13	produced in the United States or an allied or
14	partner country in sufficient and reasonably
15	available quantities or of a satisfactory quality
16	to support established or expected production
17	capabilities; or
18	"(B)(i) the use of the ineligible equipment
19	complies with the requirements set forth in the
20	Export Administration Regulations, as defined
21	in section 1742 of the Export Control Reform
22	Act of 2018 (50 U.S.C. 4801); and
23	"(ii) the Secretary, in consultation with the
24	Director of National Intelligence or the Sec-
25	retary of Defense, determines the waiver is in

- the national security interest of the United States.
- 3 "(3) FOREIGN ENTITIES OF CONCERN.—Noth-4 ing in this subsection shall be construed to waive the 5 application of section 9907.".

#### (c) Conforming Amendments.—

- (1) Section 48D(c)(1) of the Internal Revenue Code of 1986 is amended by striking "section 9901(6) of the William M. (Mac) Thornberry National Defense Authorization Act for Fiscal Year 2021" and inserting "section 9901 of the William M. (Mac) Thornberry National Defense Authorization Act for Fiscal Year 2021 (15 U.S.C. 4651)".
- (2) Section 50(a)(6)(D)(i) of the Internal Revenue Code of 1986 is amended by striking "section 9901(7) of the William M. (Mac) Thornberry National Defense Authorization Act for Fiscal Year 2021" and inserting "section 9901 of the William M. (Mac) Thornberry National Defense Authorization Act for Fiscal Year 2021 (15 U.S.C. 4651)".
- (3) Section 5949(j)(5) division E of James M. Inhofe National Defense Authorization Act for Fiscal Year 2023 (41 U.S.C. 4713 note; Public Law 117–263) is amended by striking "paragraph (7) of section 9901 of the William M. (Mac) Thornberry

- 1 National Defense Authorization Act for Fiscal Year
- 2 2021 (15 U.S.C. 4651), as added by section
- 3 103(a)(4) of the CHIPS Act of 2022 (division A of
- 4 Public Law 117–167)" and inserting "section 9901
- of the William M. (Mac) Thornberry National De-
- 6 fense Authorization Act for Fiscal Year 2021 (15

7 U.S.C. 4651)".

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